Sipex PRODUCT CHANGE NOTICE						
PART NUMBER(S):	PCN No.: 06-0130-20					
Please see attachment.	DATE: January 30, 2006					
PART DESCRIPTION:						
Power Management and Interface Products – Change in Wafer Fabrication Site						
LEVEL OF CHANGE:						
[X] Level I, Customer Approval.	[] Level II, Customer Information.					
PRODUCT ATTRIBUTE AFFECTED:						
[] Material Change	[] Data Sheet Change					
Design Change	[] Package Change					
[X] Process Change	[] Packing / Shipping					
[X] Other, Explain: Wafer Fabrication Site Transfer						
DESCRIPTION OF CHANGE:						
Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry Episil. See attached Product List no. 20.						
REASON FOR CHANGE:						
Power Management and Interface products as listed are being transferred to external wafer						
foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.						
	PRODUCT CHARACTERIZATION COMPLETED AND SAMPLES* AVAILABLE (DATE): April 25, 2006					

^{*} Samples representative of product from the Product Family being transferred.



	PRODUCT CHANGE NOTICE					
EARLIEST DATE OF PRODUC SHIPMENTS: July 24, 2006	TION					
EFFECTIVITY CHANGE DATE	OR DATE CODE:	Work week assoc	iated wit	th earliest production shipment.		
[] STANDARD DISTRIBUTI	ON		[X]	CUSTOM DISTRIBUTION		
PERSON TO CONTACT WITH	QUESTIONS:					
Fred Claussen						
VP Quality Assurance and Relia Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678	bility					



PRODUCT CHANGE NOTICE

PCN No.: 06-0130-20

List 20

SP483CN

SP483CN-L

SP483CS

SP483CS-L

SP483ECN

SP483ECN-L

SP483ECP

SP483ECP-L

SP483EEN

SP483EEN-L

SP483EEP

SP483EEP-L

SP483EN

SP483EN-L

SP483ES

SP483ES-L